

## N-Channel Enhancement Mode Power MOSFET

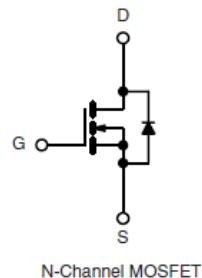
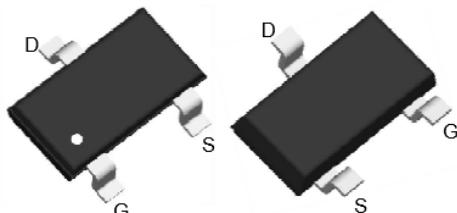
- Features

$V_{DS}$	$R_{DS(ON)TYP}$	$I_D$
20V	21 mΩ@4.5V	6A
	28 mΩ@2.5V	

- General Description

- load switch for Portable Applications
- DC/DC Converters

- Pin Configurations



SOT-23

- Absolute Maximum Ratings @  $T_A=25^\circ C$  unless otherwise noted

Parameter		Symbol	Ratings	Unit
Drain-Source Voltage		$V_{DSS}$	20	V
Gate-Source Voltage		$V_{GSS}$	$\pm 12$	V
Drain Current (Continuous) *AC	$T_A=25^\circ C$	$I_D$	6	A
	$T_A=70^\circ C$		4	
Drain Current (Pulse) *B		$I_{DM}$	25	A
Power Dissipation	$T_A=25^\circ C$	$P_D$	1.25	W
Operating Temperature/ Storage Temperature		$T_J/T_{STG}$	-55~150	°C

- Thermal Resistance Ratings

Parameter	Symbol	Typical	Maximum	Unit
Maximum Junction-to-Ambient	$t \leq 5s$	$R_{thJA}$	80	°C/W

## Electrical Characteristics

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$T_A=25^\circ\text{C}$  unless otherwise noted

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
<b>Static</b>						
Drain-Source Breakdown Voltage	$V_{(\text{BR})\text{DSS}}$	$V_{GS} = 0\text{V}$ , $I_D = 250\mu\text{A}$	20	--	--	V
Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{DS} = 20\text{V}$ , $V_{GS} = 0\text{V}$	--	--	1	$\mu\text{A}$
Gate Threshold Voltage	$V_{GS(\text{TH})}$	$V_{GS} = V_{DS}$ , $I_{DS} = 250 \mu\text{A}$	0.4	0.66	1.2	V
Gate Leakage Current	$I_{GSS}$	$V_{GS} = \pm 12\text{V}$ , $V_{DS} = 0\text{V}$	--	--	$\pm 100$	nA
Drain-Source On-state Resistance	$R_{DS(\text{on})}$	$V_{GS} = 4.5\text{V}$ , $I_D = 4\text{A}$	--	21	28	$\text{m}\Omega$
	$R_{DS(\text{on})}$	$V_{GS} = 2.5\text{V}$ , $I_D = 3\text{A}$	--	28	38	$\text{m}\Omega$
Forward Transconductance	$g_{FS}$	$V_{DS} = 10\text{V}$ , $I_D = 4\text{A}$	10	--	--	S
Diode Forward Voltage	$V_{SD}$	$I_{SD} = 1\text{A}$ , $V_{GS} = 0\text{V}$	--	--	1.2	V
Diode Forward Current	$I_S$	$T_C = 25^\circ\text{C}$	--	--	1.4	A
<b>Switching</b>						
Total Gate Charge	$Q_g$	$V_{GS} = 4.5\text{V}$ , $V_{DS} = 10\text{V}$ , $I_D = 4.5\text{A}$	--	7.7	--	nC
Gate-Source Charge	$Q_{gs}$		--	1	--	nC
Gate-Drain Charge	$Q_{gd}$		--	1	--	nC
Turn-on Delay Time	$t_{d(on)}$	$V_{DD} = 10\text{V}$ , $R_G = 1\Omega$ $I_D = 3.6\text{A}$ , $V_{GS} = 8\text{V}$	--	4	--	ns
Turn-on Rise Time	$t_r$		--	22	--	ns
Turn-off Delay Time	$t_{d(off)}$		--	16	--	ns
Turn-Off Fall Time	$t_f$		--	9	--	ns
<b>Dynamic</b>						
Input Capacitance	$C_{iss}$	$V_{GS} = 0\text{V}$ , $V_{DS} = 10\text{V}$ , $f = 1.0\text{MHz}$	--	735	--	pF
Output Capacitance	$C_{oss}$		--	110	--	pF
Reverse Transfer Capacitance	$C_{rss}$		--	40	--	pF

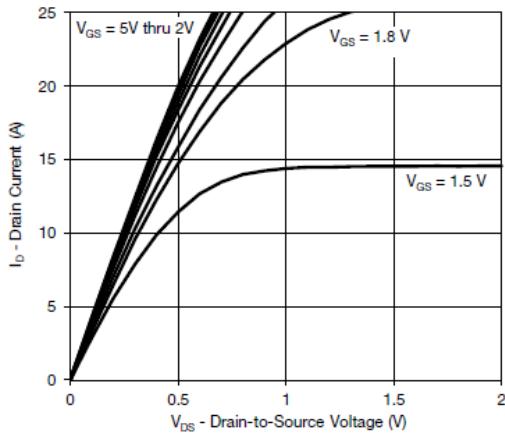
A: The value of  $R_{\theta JA}$  is measured with the device mounted on 1in<sup>2</sup> FR-4 board with 2oz. Copper, in a still air environment with  $T_A=25^\circ\text{C}$ . The value in any given application depends on the user's specific board design.

B: Repetitive rating, pulse width limited by junction temperature.

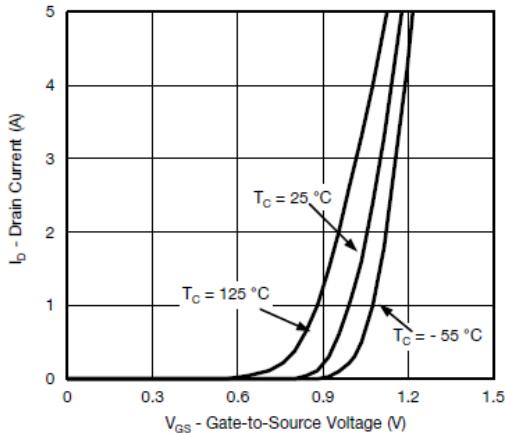
C: The current rating is based on the  $t \leq 10\text{s}$  junction to ambient thermal resistance rating.

# Typical Electrical and Thermal Characteristics

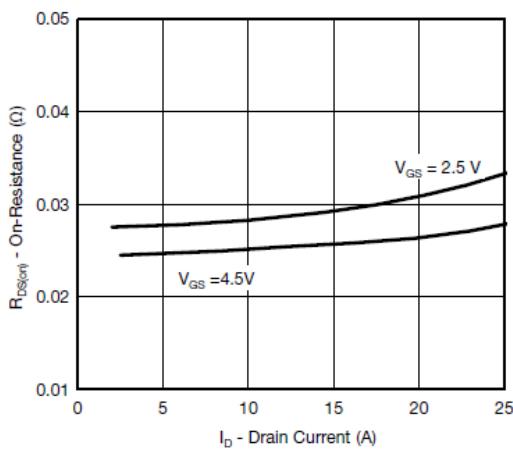
$T_J = 25^\circ\text{C}$ , unless otherwise noted



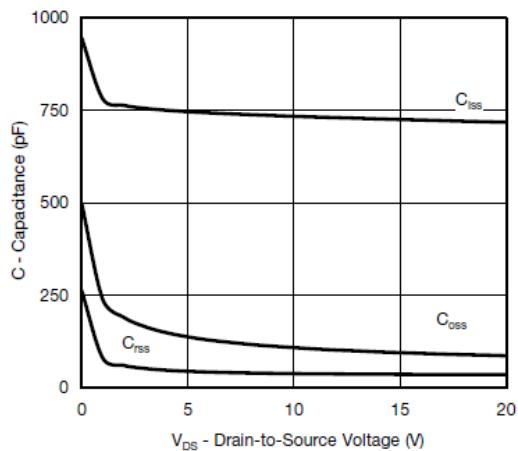
Output Characteristics



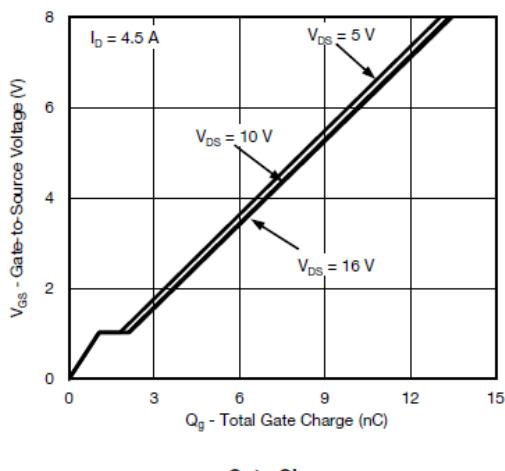
Transfer Characteristics



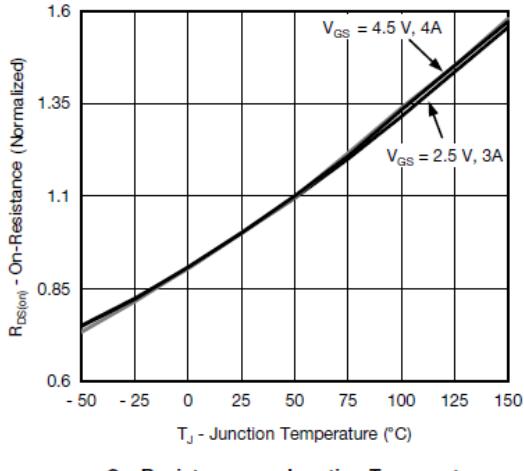
On-Resistance vs. Drain Current and Gate Voltage



Capacitance

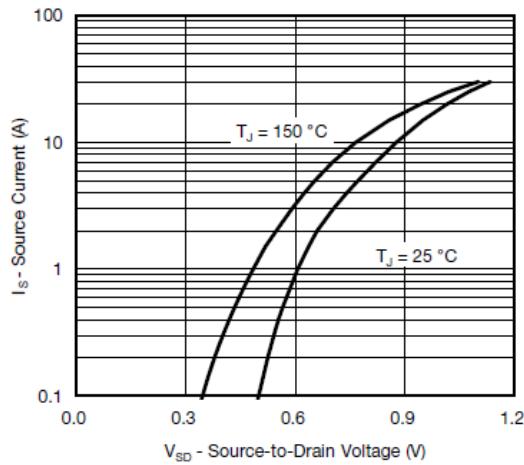


Gate Charge

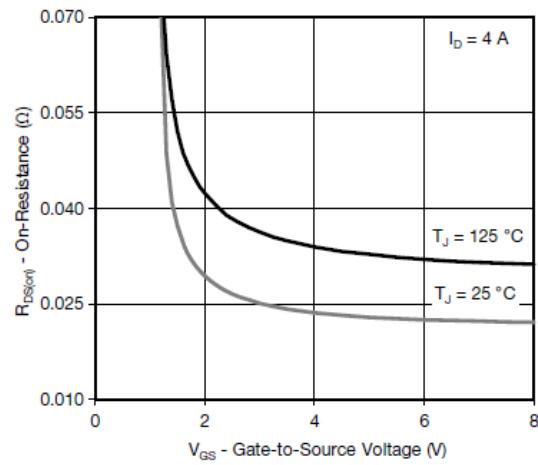


On-Resistance vs. Junction Temperature

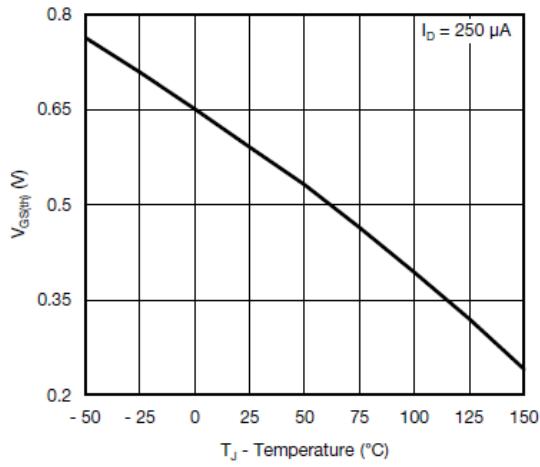
# Typical Electrical and Thermal Characteristics



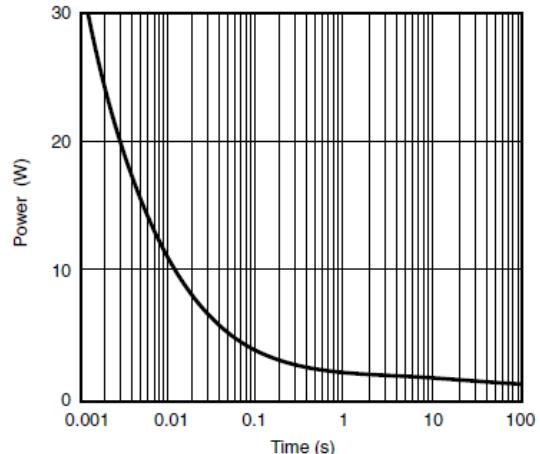
Source-Drain Diode Forward Voltage



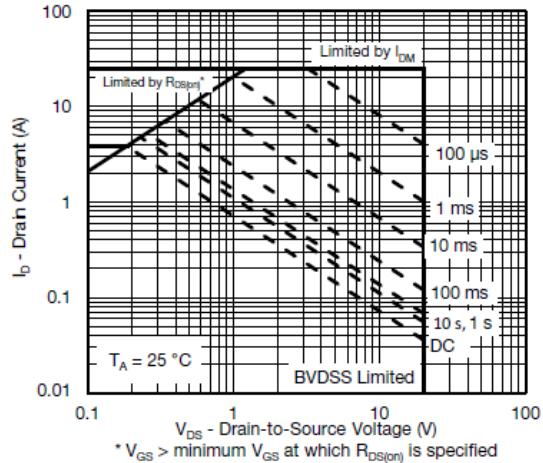
On-Resistance vs. Gate-to-Source Voltage



Threshold Voltage



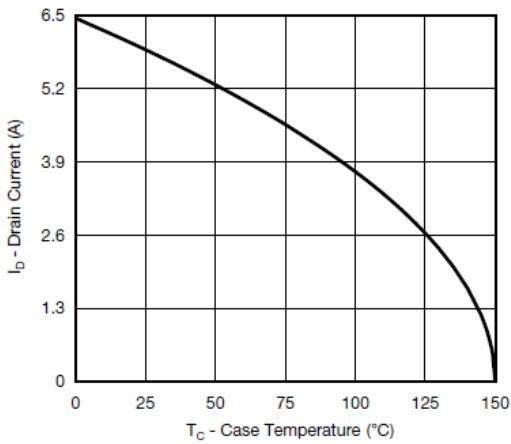
Single Pulse Power (Junction-to-Ambient)



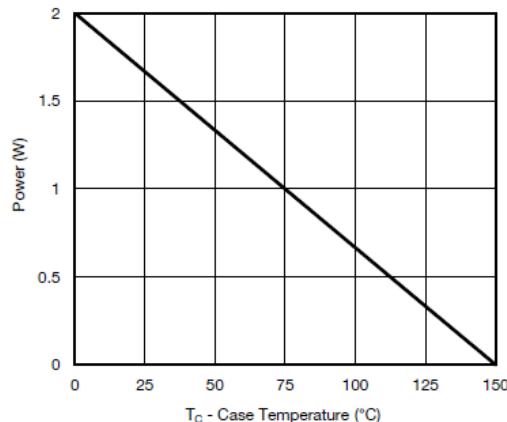
Safe Operating Area, Junction-to-Ambient

## Typical Electrical and Thermal Characteristics

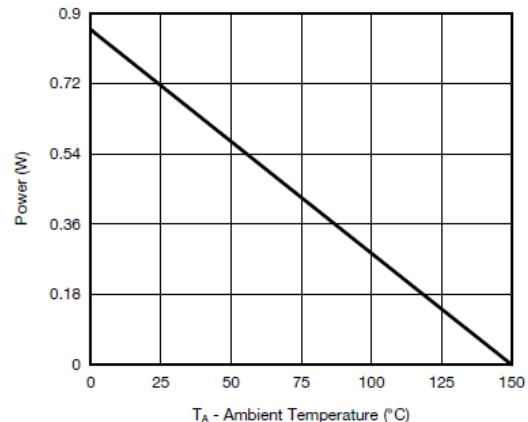
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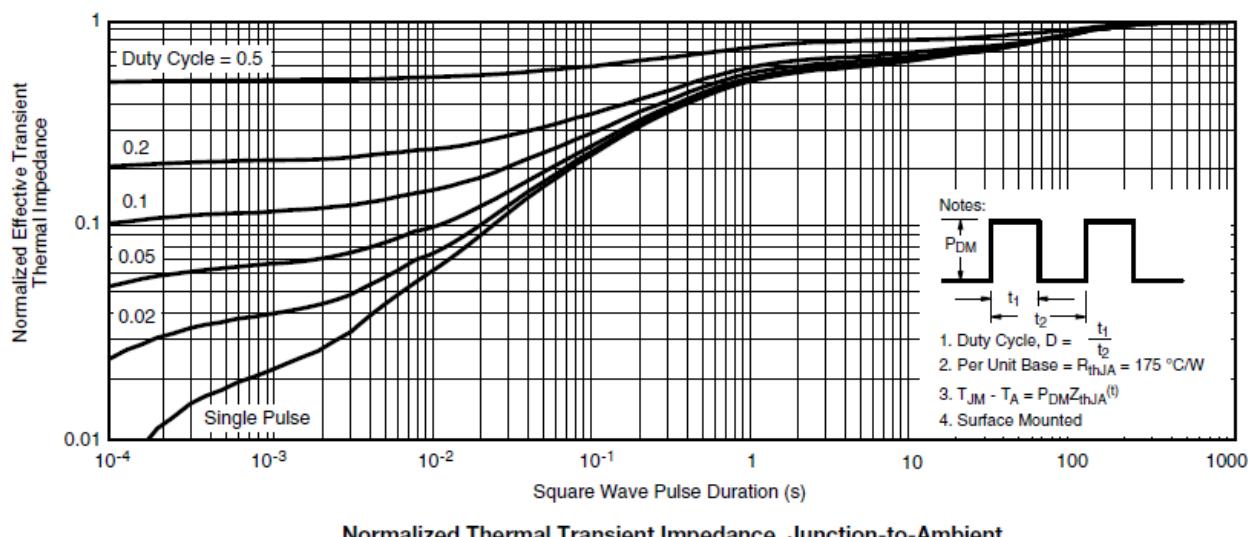
Current Derating\*



Power Junction-to-Foot



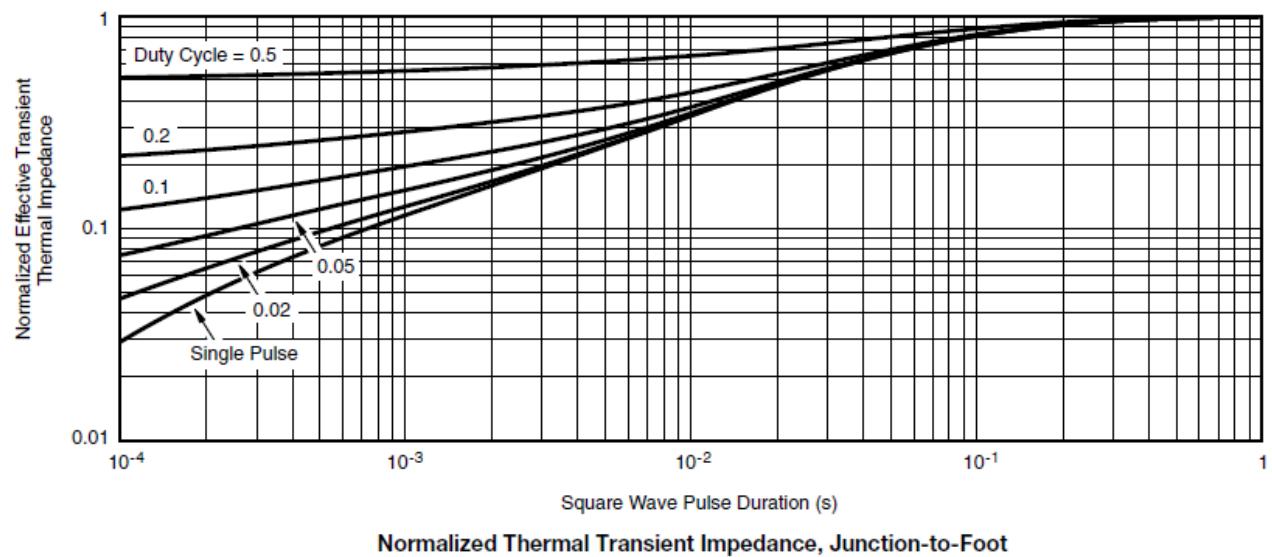
Power Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Ambient

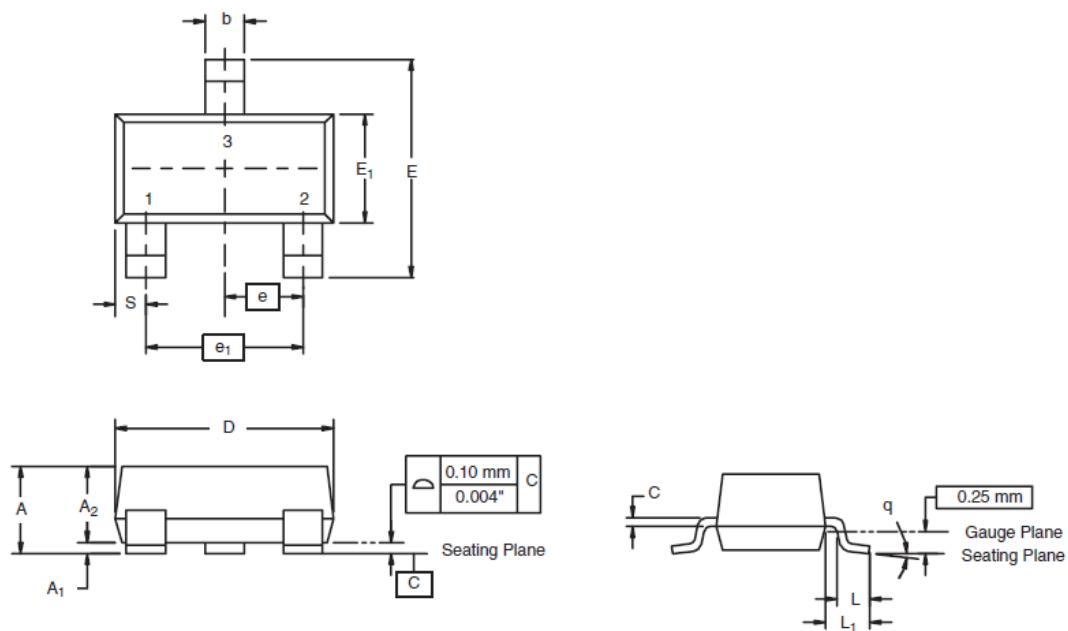
## Typical Electrical and Thermal Characteristics

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## Package Information

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Dim	MILLIMETERS		INCHES	
	Min	Max	Min	Max
A	0.89	1.12	0.035	0.044
A <sub>1</sub>	0.01	0.10	0.0004	0.004
A <sub>2</sub>	0.88	1.02	0.0346	0.040
b	0.35	0.50	0.014	0.020
c	0.085	0.18	0.003	0.007
D	2.80	3.04	0.110	0.120
E	2.10	2.64	0.083	0.104
E <sub>1</sub>	1.20	1.40	0.047	0.055
e	0.95 BSC		0.0374 Ref	
e <sub>1</sub>	1.90 BSC		0.0748 Ref	
L	0.40	0.60	0.016	0.024
L <sub>1</sub>	0.64 Ref		0.025 Ref	
S	0.50 Ref		0.020 Ref	
q	3°	8°	3°	8°